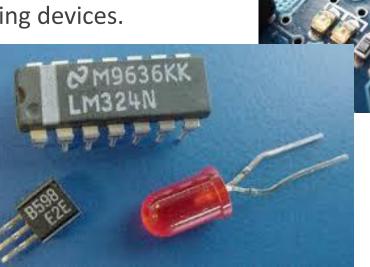
# Electronic Materials

#### What are they?

Materials that conduct electricity

**Used** in electrical industries, electronics and microelectronics, and the substances for the building up of integrated circuits, circuit boards, packaging materials, communication cables, optical fibres, displays, and various controlling and monitoring devices.



#### Ohm's Law

$$V = IR$$

Where V is the voltage (volts, V), I is the current (amperes or amps, A), and R is the resistance (ohms).

$$R = \rho \frac{l}{A} = \frac{l}{\sigma A}$$

where I is the length (cm) of the resistor, A is the cross-sectional area (cm<sup>2</sup>) of the resistor,  $\rho$  is the electrical resistivity (ohm.cm), and , which is the reciprocal of  $\sigma$ , is the electrical conductivity (ohm<sup>-1</sup> cm<sup>-1</sup>).

Metals: High conductivity

**Insulators: Low Conductivity** 

Semiconductors: Conductivity can be varied by several orders of magnitude.

# Using Ohm's law

$$P = IV = I^2R$$

The electrical power **P** (in watts, W) lost when a current flows through a resistance.

$$J = \frac{I}{A} = \sigma \frac{V}{l} = \sigma E = nqv$$

$$\mu = \frac{\nu}{E} = \frac{\sigma}{nq}$$

J: Current density(A/cm<sup>2</sup>)

E: Electric field (V/cm)

n: number of charge carriers (carriers/cm³)

q: charge on each carrier (1.6×10<sup>-19</sup> C)

 $\nu$ : the average drift velocity (cm/s) at which the charge carriers move

 $\mu$ : Mobility (cm<sup>2</sup> /V s)

A voltage of 1700 V is applied to a gold wire 25 m in length. Calculate the diameter of wire and current density if the resistance is 3 ohm

Design an electrical transmission line 1500 m long that will carry a current of 50 A with no more than  $5 \times 10^5$  W loss in power.

Material	Conductivity $(\Omega^{-1}m^{-1})$
Aluminum	$3.5 \times 10^{7}$
Copper	$6.0 \times 10^{7}$
Gold	$4.1 \times 10^{7}$
Iron	$1.0 \times 10^{7}$
Silver	$6.2 \times 10^{7}$
Tungsten	$1.8 \times 10^{7}$
Nichrome*	$6.7 \times 10^{5}$
Carbon	$2.9 \times 10^4$

A current density of 5000 A/cm2 is applied to a Aluminum wire. If half of the valence electrons serve as charge carriers, calculate the average drift velocity of the electrons

# How does conductivity work?

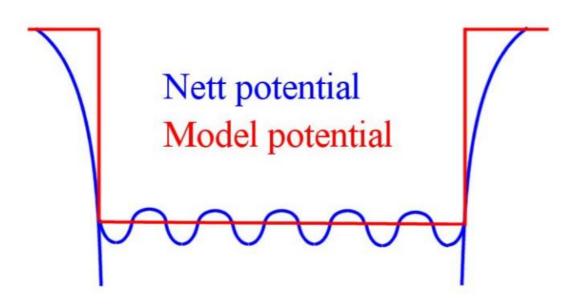
#### 1. FREE ELECTRON MODEL

Assumptions: e- are not interacting with each other

e- respond equally to an external field

inner e- are localized

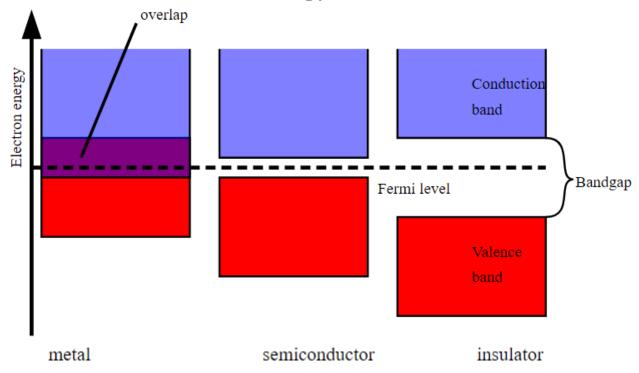
Constant potential



## How does conductivity work?

#### 2. BAND THEORY

Describes the conduction in terms of the energy to excite an e-



#### BAND THEORY

In order for e- to jump from one band to another, the energy must accelerate the e- enough to promote it to energy empty states.

<u>Fermi Energy (Ef):</u> Energy level at which only half of the energy levels in the band are field at ABSOLUTE ZERO

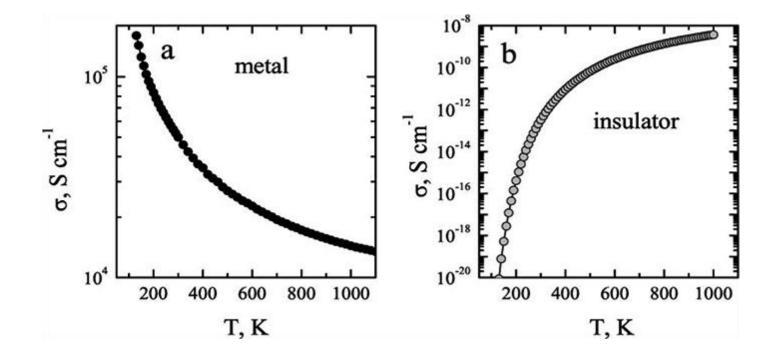
What happens with Non-metals? Due to covalent bonding the energy needed to excite an e- will form a hybrid band between s and p levels.

#### Response to temperature

#### By the way

Siemens is a resistivity unit

$$S = \Omega^{-1}$$



If all valence e- contribute to the current flow in Cu, calculate:

a) Mobility of e- and, b) average drift velocity of e- in 100cm long wire when 10V are applied

 $a_0 = 3.51E-18 \text{ cm}$ 

FCC structure

 $\sigma$ = 5.98E5  $\Omega^{-1}$  cm<sup>-1</sup>

# Conductivity of Metals and Alloys

Conductivity is defined by the electronic structure of the material, if and only, the material is pure and defect-free.

$$\sigma = nq\mu$$

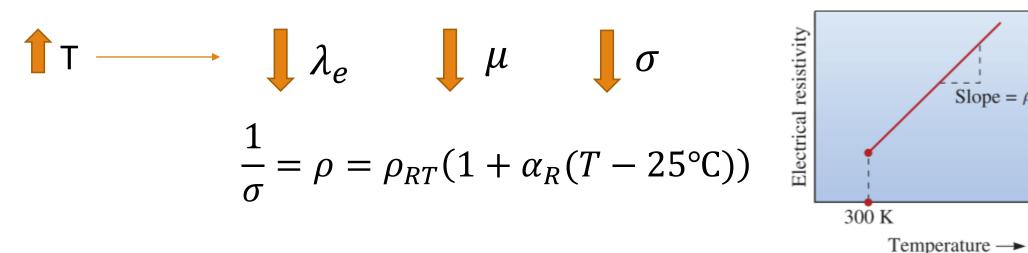
The paths of electrons are influenced internal fields due to the atoms present in the solid and imperfections present in the lattice.

$$\lambda_e = \tau v$$

 $\lambda_e$ : Mean free path

τ: Average time between collisions

# Conductivity of Metals and Alloys: Temperature effect



Slope =  $\rho_{RT}\alpha_R$ 

 $\rho_{RT}$ : Resistivity at room temperature ( $\Omega^*$ cm)

 $\alpha_R$ : Temperature resistivity coefficient ( $\Omega/\Omega$  °C)

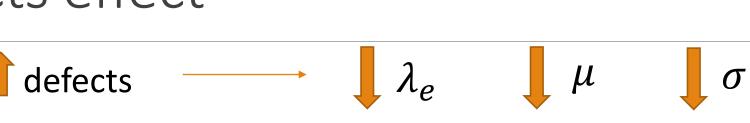
T: New temperature (°C)

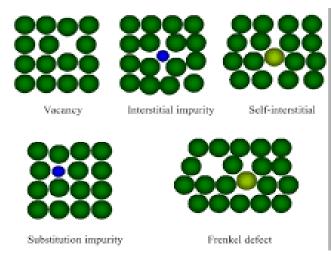
After finding the electric conductivity of cobalt at 0 °C, we decide to double de conductivity. To what temperature must we cool the metal?

<b>TABLE 19-3</b> ■	The temperature	resistivity coeffic	cient $lpha_{R}$ for	selected metals
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Metal	Room Temperature Resistivity (ohm · cm)	Temperature Resistivity Coefficient $(\alpha_R)$ [ohm/(ohm $\cdot$ °C)]		
Be	4.0×10 <sup>-6</sup>	0.0250		
Mg	$4.45 \times 10^{-6}$	0.0037		
Ca	$3.91 \times 10^{-6}$	0.0042		
Al	$2.65 \times 10^{-6}$	0.0043		
Cr	$12.90 \times 10^{-6} (0^{\circ}\text{C})$	0.0030		
Fe	$9.71 \times 10^{-6}$	0.0065		
Co	$6.24 \times 10^{-6}$	0.0053		
Ni	$6.84 \times 10^{-6}$	0.0069		
Cu	$1.67 \times 10^{-6}$	0.0043		
Ag	$1.59 \times 10^{-6}$	0.0041		
Au	$2.35 \times 10^{-6}$	0.0035		
Pd	$10.8 \times 10^{-6}$	0.0037		
W	$5.3 \times 10^{-6}$ (27°C)	0.0045		
Pt	$9.85 \times 10^{-6}$	0.0039		

#### Conductivity of Metals and Alloys: Defects effect





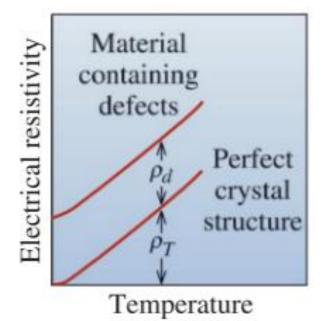
$$\rho_d = bx(1-x)$$

 $\rho_d$ : Resistivity due to defects( $\Omega^*$ cm)

b: Defect resistivity coefficient ( $\Omega^*$ cm)

x: fraction of impurity

$$\rho = \rho_t + \rho_d$$



#### Semiconductors

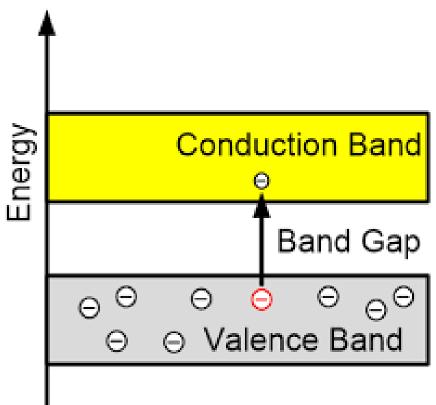
Any of a class of crystalline solids intermediate in electrical conductivity between a conductor and an insulator.

Key elements for the majority of electronic systems, serving communications, signal processing, computing, and control applications in both the consumer and industrial markets.

Energy gap (Eg) between the valence and conduction bands is relatively small.

**Intrinsic semiconductors**: Properties independent of the impurities.

**Extrinsic semiconductors**: Temperature stable and can be controlled by ion implantation or diffusion of impurities known as dopants.



#### Intrinsic semiconductors

For every electron promoted to the conduction band, there is a hole left in the valence band.

$$\sigma = n_i q(\mu_n + \mu_p)$$

 $n_i$ : Concentration of e-

 $\mu_n$ : Mobility of e-

 $\mu_p$ : Mobility of holes (h+)

$$\mu_n > \mu_p$$

Intrinsic semiconductors: Temperature effect 
$$n_i = n_0 exp\left(\frac{-E_g}{2k_BT}\right) \qquad n_0 = 2\left(\frac{2\pi k_BT}{h^2}\right)^{3/2} (m_n^*m_p^*)^{3/4}$$

$$\sigma = n_0 q(\mu_n + \mu_p) exp\left(\frac{-E_g}{2k_BT}\right)$$

$$k_B: \text{Boltzmann's constant } (1.38 \times 10^{-23} \text{ m}^2 \text{ kg s}^{-2} \text{ K}^{-1} \text{ or } \textbf{8.63} \times \textbf{10}^{-5} \text{ eV/K})$$

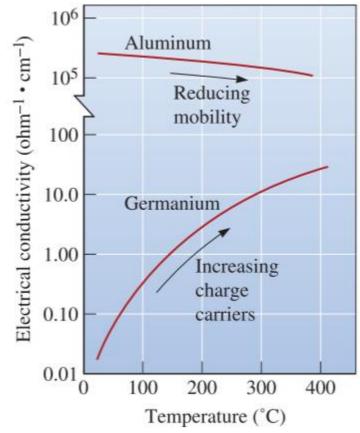
$$h: \text{Planck's constant } (6.63 \times 10^{-34} \text{ m}^2 \text{ kg}/\text{s})$$

$$m_n^*: \text{ Effective mass of } e$$

$$\sigma = n_0 q(\mu_n + \mu_p) exp\left(\frac{-E_g}{2k_B T}\right)$$

 $m_n^*$ : Effective mass of e-

 $m_p^*$ : Effective mass of h+



For germanium and silicon, compare, at 25°C, the number of charge carriers per cubic centimeter, the fraction of the total # electrons in the valence band that are excited into the conduction band, and the constant n0

TABLE 19-5 ■ Properties of commo	nly encountered	semiconductors at	room temperature
----------------------------------	-----------------	-------------------	------------------

a0	(Si)	=	5.43E-8	cm
a0	(Ge)	=	5.66E-8	cm

Semiconductor	Bandgap (eV)	Mobility of Electrons ( $\mu_n$ ) $\left(\frac{\text{cm}^2}{\text{V-s}}\right)$	Mobility of Holes ( $\mu_p$ ) $\left(\frac{\text{cm}^2}{\text{V-s}}\right)$	Dielectric Constant (k)	Resistivity $(\Omega \cdot \text{cm})$	$\frac{\text{Density}}{\left(\frac{\text{g}}{\text{cm}^2}\right)}$	Melting Temperature (°C)
Silicon (Si)	1.11	1350	480	11.8	$2.5 \times 10^{5}$	2.33	1415
Amorphous Silicon (a:Si:H)	1.70	1	10-2	~11.8	10 <sup>10</sup>	~2.30	_
Germanium (Ge)	0.67	3900	1900	16.0	43	5.32	936
SiC (α)	2.86	500		10.2	10 <sup>10</sup>	3.21	2830
Gallium Arsenide (GaAs)	1.43	8500	400	13.2	$4 \times 10^8$	5.31	1238
Diamond	~5.50	1800	1500	5.7	> 10 <sup>18</sup>	3.52	~3550

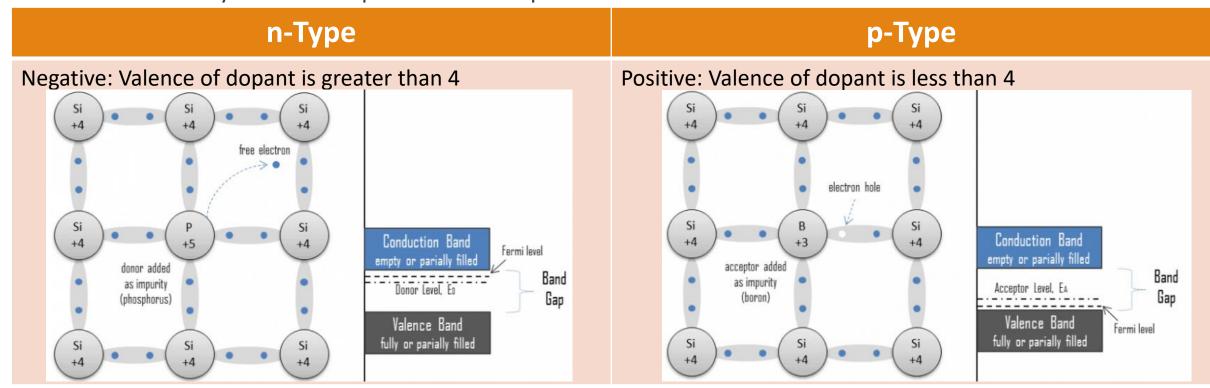
For germanium and silicon, compare, at 25°C, the number of charge carriers per cubic centimeter, the fraction of the total # electrons in the valence band that are excited into the conduction band, and the constant n0

	Ge	Si
n (e-/cm <sup>3</sup> )	2.51E13	1.37E10
$n_t$ (e-/cm <sup>3</sup> )	1.77E23	1.998E23
Fraction	1.42E-10	6.85E-14
n <sub>0</sub> (carriers/cm <sup>3</sup> )	1.14E19	3.27E19

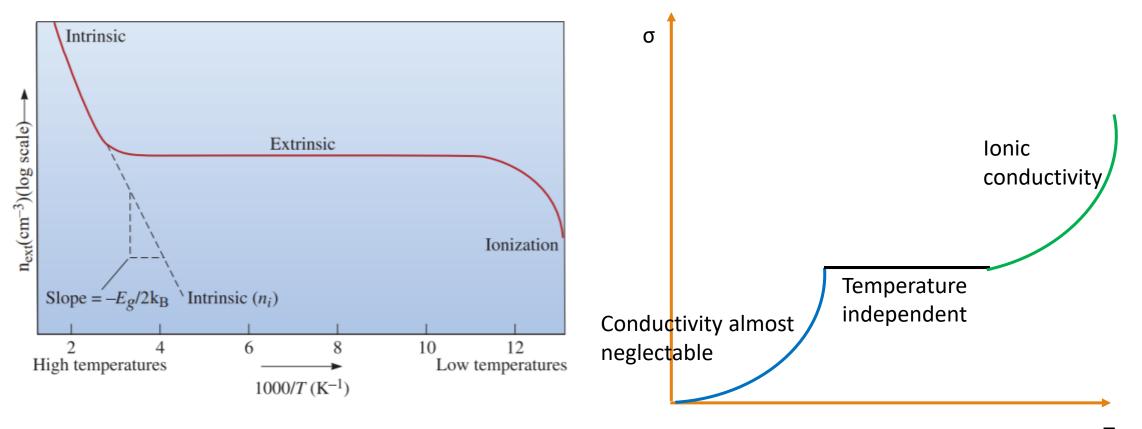
#### Extrinsic Semiconductors

Conductivity is based on the addition of impurities (Doping)

Conductivity can be independent of temperature



# Extrinsic Semiconductors: Temperature dependence



Determine the electrical conductivity of silicon when 0.0001at% Sb is added as a dopant. Compare it to the electrical conductivity when the same percentage of In is added.

TABLE 19-6 ■ The donor and acceptor energy levels (in electron volts) when silicon and germanium semiconductors are doped

	Silicon		Germanium		
Dopant	$E_d$	Ea	$E_d$	Ea	
P	0.045		0.0120		
As	0.049		0.0127		
Sb	0.039		0.0096		
В		0.045		0.0104	
Al		0.057		0.0102	
Ga		0.065		0.0108	
ln		0.160		0.0112	

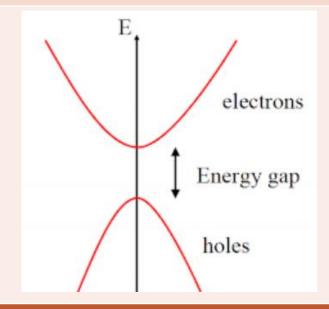
#### Bandgap Semiconductors

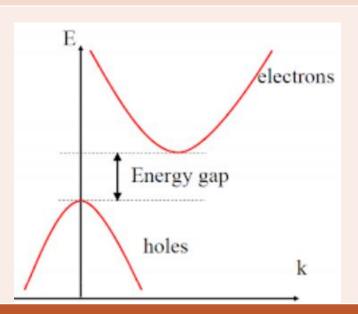
#### **Direct (DBG) semiconductor**

- The maximum energy level of the valence band aligns with the minimum energy level of the conduction band.
- The probability of a radiative recombination is high.
- DBG semiconductors are always preferred over IBG for making optical sources.
- Example, Gallium Arsenide (GaAs).

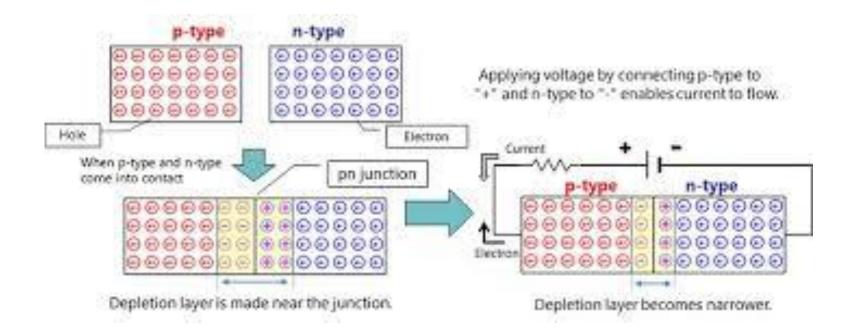
#### **Indirect (IBG) semiconductor**

- The maximum energy level of the valence band and the minimum energy level of the conduction band are misaligned.
- Heat
- Example, Silicon and Germanium.

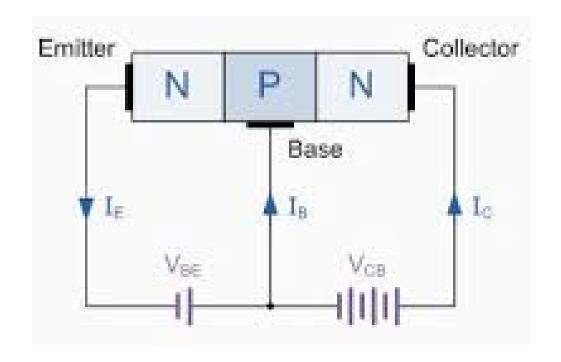


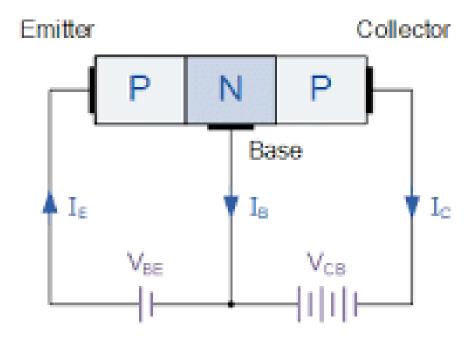


#### p-n Junction



#### **Transistors**





### Conductivity in other materials: Polymers

 $-10^{-8}$ ,  $10^{-12} \Omega^{-1}$  cm<sup>-1</sup>

- Covalent bonds

Polyacetylene

Polypyrrole

#### Dope with:

CIO<sub>4</sub>

AsF<sub>5</sub>

+ Composite materials:

**Powders** 

Coatings

Polythiophene

Polyaniline

### Conductivity in other materials: Ceramics

- Ionic material
- entire ions move, not just e-

$$\mu = \frac{zqD}{k_BT} \qquad \sigma = n_i zq\mu$$

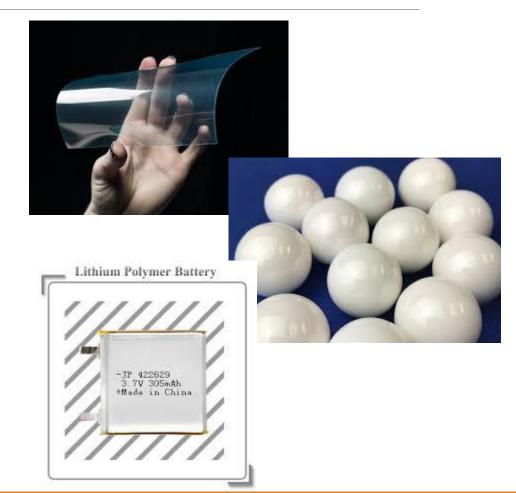
 $D = D_0 exp\left(\frac{-Q}{RT}\right)$ 

Z: valence of the ion

q: charge on each carrier (1.6×10-19 C)

D: diffusion coefficient

ni: concentration of diffusing ions

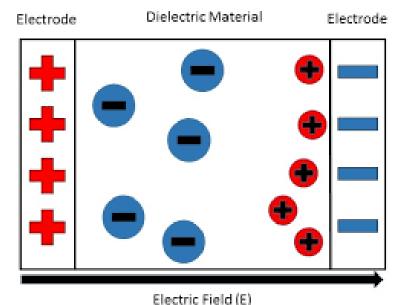


Suppose that the electrical conductivity of MgO is determined primarily by the diffusion of the Mg2+ ions. Estimate the mobility of the Mg2+ ions and calculate the electrical conductivity of MgO at 1500°C.

 $D_0$ =0.705 10<sup>-13</sup> [cm<sup>2</sup> s<sup>-1</sup>] Q= 1.25 10<sup>5</sup> J a0=3.96E-8 cm

# Dielectric and insulating materials: Polarization

#### Charge separation!

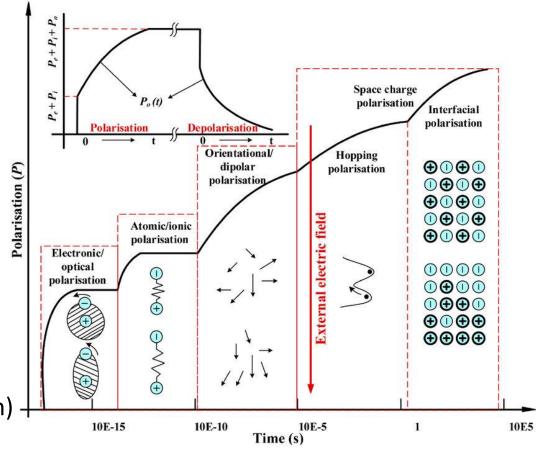


 $\bigcup = qd$  P = zqd

P: polarization

z: Number of charges displaced per unit volume

d: average displacement (m)



Calculate the displacement of e- if the polarization of Al is 2E-8 C m<sup>-2</sup>

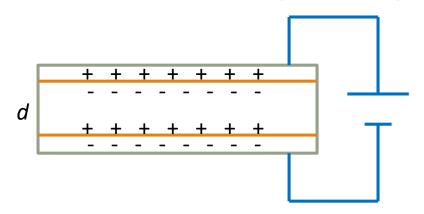
Atomic number: 13

a0: 4.04E-8 cm

FCC structure

#### Dielectric constant (k)

#### Also known as Relative permittivity



$$Q = CV k = \frac{\varepsilon}{\varepsilon_0}$$

$$C = \varepsilon \frac{A}{d} \qquad C = k\varepsilon_0 \frac{A}{d}$$

Q: Stored charge (C)

C: capacitance (Farad)

V: voltage (V)

A: Surface area (m2)

d: average displacement (m)

 $\varepsilon$ : permittivity of material (F/m)

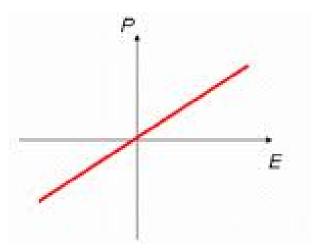
 $\varepsilon_0$ : Permittivity of vacuum (8.85E-12 F/m)

A simple parallel plate capacitor is designed to store 5E-6 C at a potential of 8000 V. The distance between plates if 0.30 mm. Calculate the area of the plates if a) there is vacuum in between and b) alumina is the chosen dielectric material, if the permittivity of this material is 9 times the vacuum permittivity.

#### Linear and non-Linear dielectrics

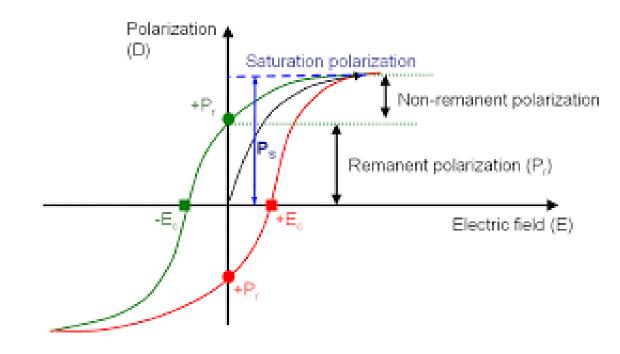
Polarization only occurs when an electric field is applied

$$P=(k-1)\varepsilon_0 E$$
  $V=Ed$   $x=(k-1)$ : Dielectric susceptibility



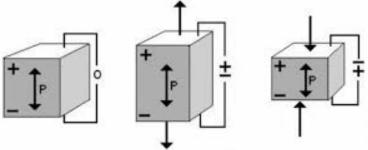
E: Electric field (V/m)

#### Polarization has a remnant even after the electric field is removed

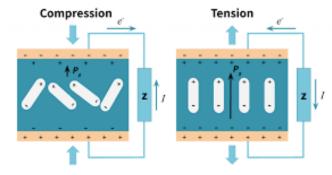


#### Non-Linear dielectrics

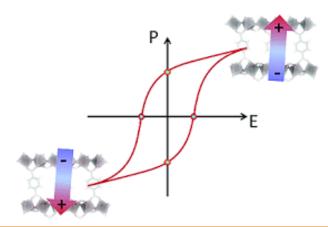
Electrostricticity: Dimensional change in the material when there is E.



Piezoelectricity: Application of stress on some materials can produce polarization



Ferroelectricity: Spontaneous and reversible dielectric polarization (Ps).



A 2-mm-thick alumina dielectric is used in a 60 Hz circuit. Calculate the voltage required to produce a polarization of 5E-7 C/m<sup>2</sup>

	Dielectric	Constant	Dielectric		
Material	(at 60 Hz)	(at 10 <sup>6</sup> Hz)	Strength (10 <sup>6</sup> V/m)	tan δ (at 10 <sup>6</sup> Hz)	Resistivity (ohm · cm)
Polyethylene	2.3	2.3	20	0.00010	> 10 <sup>16</sup>
Teflon	2.1	2.1	20	0.00007	$10^{18}$
Polystyrene	2.5	2.5	20	0.00020	$10^{18}$
PVC	3.5	3.2	40	0.05000	10 <sup>12</sup>
Nylon	4.0	3.6	20	0.04000	$10^{15}$
Rubber	4.0	3.2	24		
Phenolic	7.0	4.9	12	0.05000	$10^{12}$
Ероху	4.0	3.6	18		$10^{15}$
Paraffin wax		2.3	10		$10^{13} - 10^{19}$
Fused silica	3.8	3.8	10	0.00004	$10^{11} - 10^{12}$
Soda-lime glass	7.0	7.0	10	0.00900	$10^{15}$
$Al_2O_3$	9.0	6.5	6	0.00100	$10^{11} - 10^{13}$
TiO <sub>2</sub>		14-110	8	0.00020	$10^{13} - 10^{18}$
Mica		7.0	40		$10^{13}$
BaTiO <sub>3</sub>		2000-5000	12	~0.0001	$10^{8} - 10^{15}$
Water		78.3			$10^{14}$

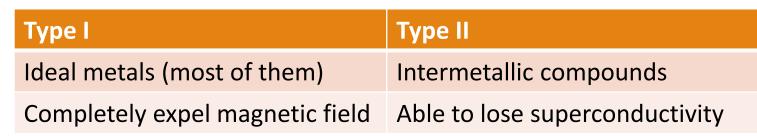
# Superconductivity

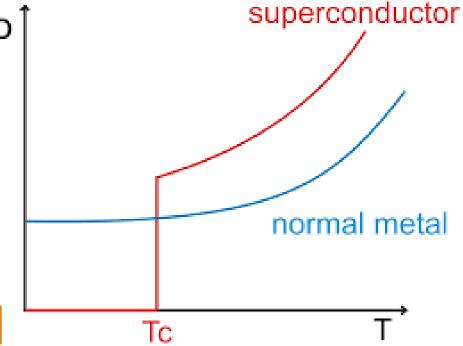
Zero resistance

Temperature dependent

Meissner effect: Response of the superconductor to a magnetic field. A new opposing field.

Critical magnetic field: Magnitude of field needed to eliminate the superconductivity property of the material.





The electrical resistivity of beryllium alloy containing 5at% of an alloying element is found to be 50E6  $\Omega$  cm at 400°C.

Determine the contributions to resistivity due to temperature and due to impurities by finding the expected resistivity of pure beryllium at 400°C, the resistivity due to impurities, and the defect resistivity coefficient.

What would be the electrical resistivity if beryllium contained 10 at% of the same alloying element at 200°C?

 $\rho_{RT}$ : 4E-6 Ω cm

 $\alpha_R {:}~0.025~1/^{\circ}C$ 

Design a capacitor that is capable of storing 1  $\mu$ F when 1000 V is applied, producing an electric field of 250 V/m and the distance between plates is a fifth of the side of a plate.